

# High Performance & Flexible Printer

# SP1-W

## A New Standard in High Performance and Flexible Printing

The SP1-W screen printer offers increased print size for large board applications while maintaining Industry leading accuracy specifications. With its high print quality and reduced cleaning time, the SP1-W screen printer increases productivity, maximizing throughput and ROI Available in a dual lane architecture it can also provide mixed production of 2 different PCB models at the same time.



- Printing Accuracy : 12.5μm@6σ
- Printing Cycle Speed: 7 sec
- Applicable PCB: 510(L) x 460(W) (Single Lane)

330(L) x 310(W) (Dual Lane)

- Stencil Size : Max. 736(L) x 736(W)
- Machine Size: 1,540(W) x 1,650(D)
- Mixed Production of Different Types of PCBs / Automatic Stencil Position Setting / SPI Feedback / Advanced Software Interface
- Options Include Dual Lane Configuration and Extension Conveyors

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# Greater Range of PCB and Stencil Sizes

#### Supports PCBs up to 510 x 460mm

- Allows dual mode operation up to 330 x 250mm.
- Provides printing accuracy of 12.5μm@6σ with a printing cycle time of 7 seconds.

#### Multiple stencil sizes

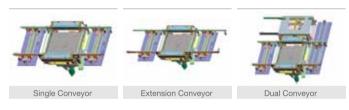
 Supports sizes from 550 ~ 736mm and the variable support allows quick change between types with indexes at 550, 600, 650 and 736mm



# Configurable with Various Conveyor Types

# Allows conveyor configuration according to the user's production environment

• Single, dual and extension conveyors supported.



# **Reduced Cleaning Time**

Increases productivity by reducing the cleaning time by improving the cleaning sequence.

# One Touch Squeegee Replacement

Allows easy squeegee replacement by changing the manual screw attachment to an instant removal and installation method.



# **Increased User Convenience**

#### Allows mixed production of different types of PCBs

 Allows inline operation with two sets of printers by applying a dual-lane conveyor (bypass) for high speed and mixed production.

#### 2D barcode tracking function

 Allows tracking of printing defects by recognizing the 2D barcode attached to a PCB and saving the PCB information.

#### SPI feedback function

 Improves the printing quality and defect ratio by performing automatic inspection and cleaning of the mask openings after receiving feedback from SPI stage.



#### Default PCB program

 Minimizes user operation requirements during printing conditions by providing a default PCB program.

Automatic solder paste supply Automatic stencil position setting Automatic print height leveling Environmental control unit (External type) Circulation blower (Internal type)



### Specifications

Model			SP1-W
Cycle Time			7sec
Alignment			±12.5μm@6σ
Wet Print			±25μm@6σ
Board Handling	Minimum(mm)		50(L) × 50(W)
	Maximum(mm)	Single	510(L) × 460(W)
		Dual	330(L) x 310(W)
	Board Thickness(mm)		0.4 ~ 5.0
Stencil	Minimum(mm)		550(L) × 650(W) 650(L) × 550(W)
	Maximum(mm)		736(L) x 736(W)
	Frame Thickness(mm)		30 ~ 40
	Matching		Center Standard
Vision	Function		Fiducial Recognition Inspection
	FOV(mm)		10.6 x 8.0
	Fiducial Shape		●,▲,■,◆,+
Utility	Power		100/110/120/200/220/240V Single Phase(50/60Hz) Max. 4.5kVA
	Air Supply		Pressure 4.5 ~ 7.0kgf/cm <sup>2</sup> Max. 600 ~ 700N1/min
Mass			Approx. 1,620kg
External Dimension(mm)			1,540(W) x 1,650(D) x 1,447(H)



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